



Package: eSGB (SMAF)

Features

- Glass passivated standard rectifiers
- Ideal for automated placement
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260°C, 10 seconds
- Low profile



Applications

For use of general purpose rectification in lighting, cellular phones, portable devices, power supplies, and other consumer applications.

Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	L2A1	L2A2	L2A3	L2A4	L2A5	L2A6	L2A7	Unit
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at T _L (See Fig.1)	I _{F(AV)}				2.0				A
Peak Forward Surge Current (8.3 ms single half sine-wave superimposed on rated load)	I _{FSM}				55				A
Operating Junction and Storage Temperature	T _J , T _{STG}				- 55 to + 150				°C

Electrical Characteristics (T_A=25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	L2A1	L2A2	L2A3	L2A4	L2A5	L2A6	L2A7	Unit
Maximum Instantaneous Forward Voltage	2 A	V _F				1.1				V
Maximum DC Reverse Current at rated DC Blocking Voltage	T _A =25°C	I _R				5				μA
	T _A =125°C					50				
Typical Reverse Recovery Time	I _F =0.5A, I _R =1.0A, I _R =0.25A	t _{rr}				1.8				μs
Typical Junction Capacitance	4.0 V, 1 MHz	C _J				6				pF

Ratings and Characteristic Curves

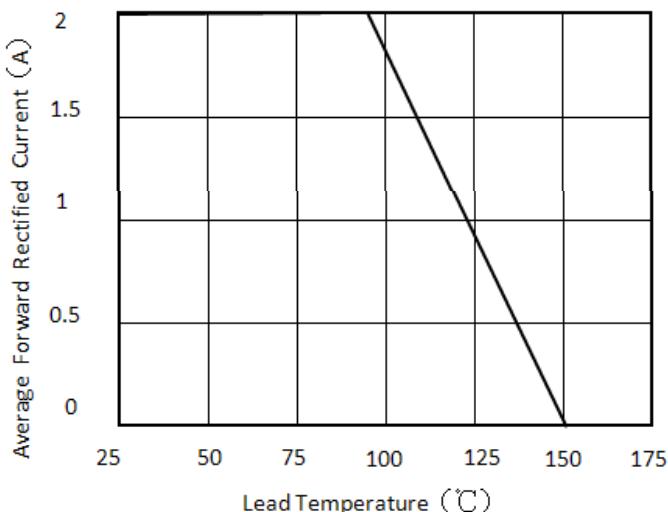


Figure 1. Forward Current Derating Curve

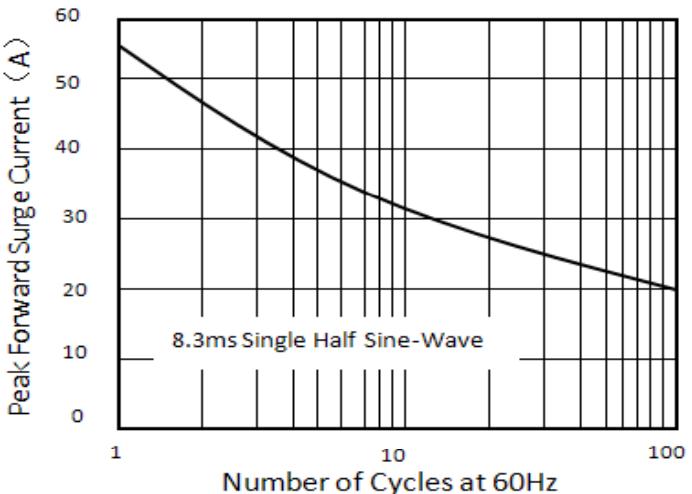


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

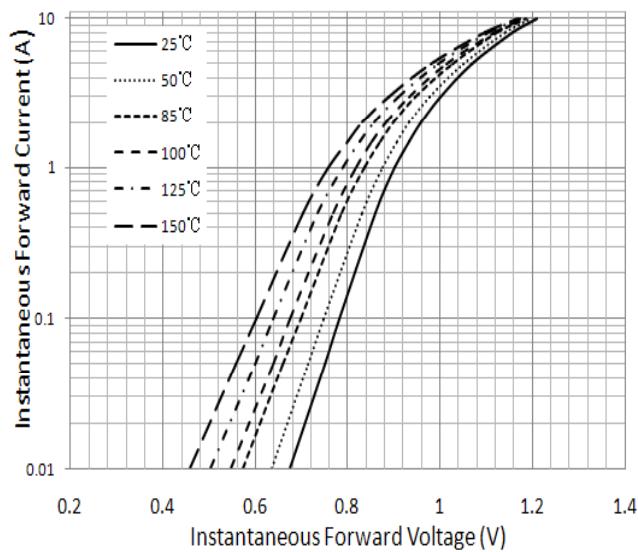


Figure 3. Typical Instantaneous Forward Characteristics

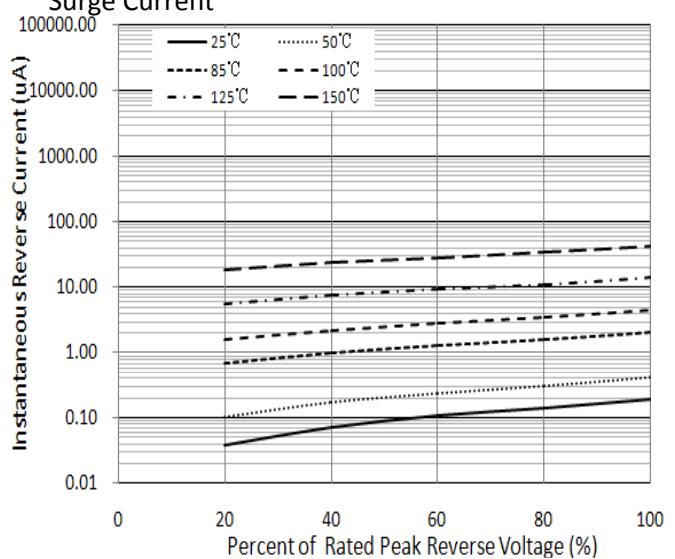


Figure 4. Typical Reverse Characteristics

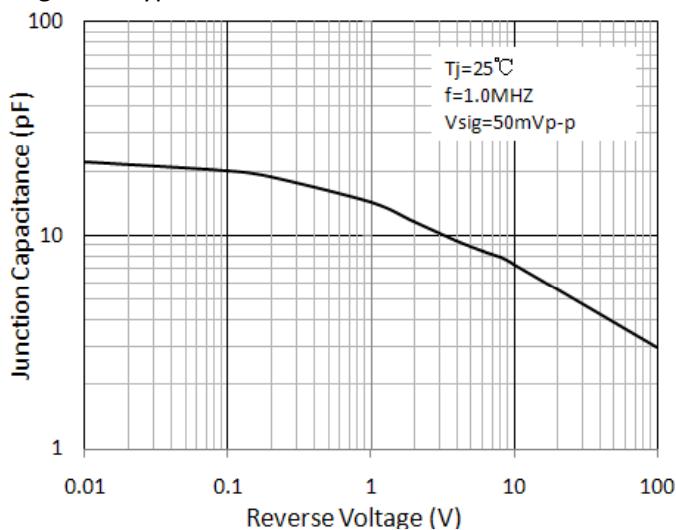
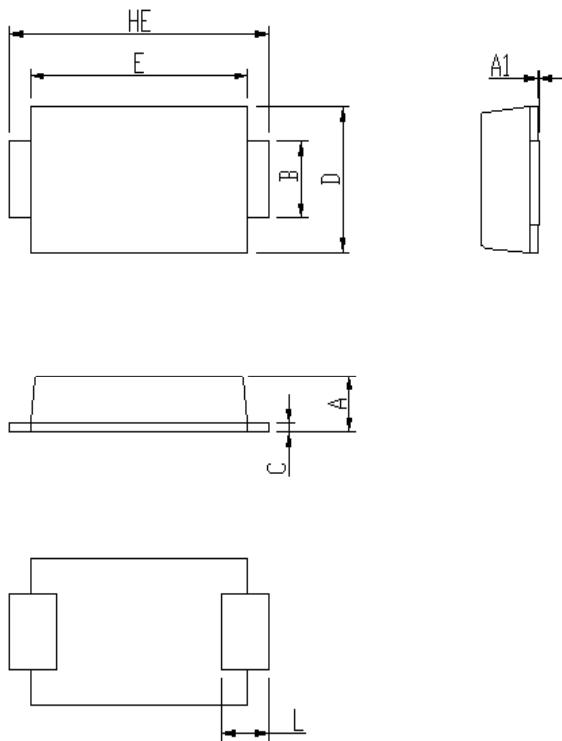


Figure 5. Typical Junction Capacitance

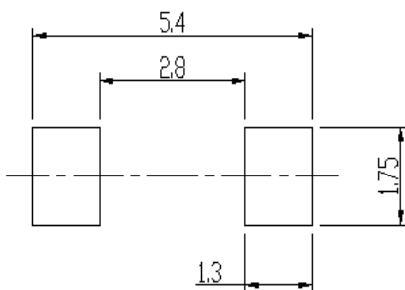
Package Outline Dimensions

eSGB (SMAF)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.92	1.08	0.036	0.043
A1	0	0.1	0.000	0.004
B	1.25	1.45	0.049	0.057
C	0.1	0.25	0.004	0.010
D	2.6	2.8	0.102	0.110
E	4.1	4.3	0.161	0.169
L	0.7	1.1	0.028	0.043
HE	4.8	5.2	0.189	0.205

Soldering footprint



Packing Information

Packing quantities:

3000 pcs/Reel, 12mm Tape, 13" Reel

Tape & Reel Specification

